BCD-to-Seven Segment Latch/Decoder/Driver for Liquid Crystals

The MC14543B BCD-to-seven segment latch/decoder/driver is designed for use with liquid crystal readouts, and is constructed with complementary MOS (CMOS) enhancement mode devices. The circuit provides the functions of a 4-bit storage latch and an 8421 BCD-to-seven segment decoder and driver. The device has the capability to invert the logic levels of the output combination. The phase (Ph), blanking (BI), and latch disable (LD) inputs are used to reverse the truth table phase, blank the display, and store a BCD code, respectively. For liquid crystal (LC) readouts, a square wave is applied to the Ph input of the circuit and the electrically common backplane of the display. The outputs of the circuit are connected directly to the segments of the LC readout. For other types of readouts, such as light-emitting diode (LED), incandescent, gas discharge, and fluorescent readouts, connection diagrams are given on this data sheet.

Applications include instrument (e.g., counter, DVM etc.) display driver, computer/calculator display driver, cockpit display driver, and various clock, watch, and timer uses.

Features

- Latch Storage of Code
- Blanking Input
- Readout Blanking on All Illegal Input Combinations
- Direct LED (Common Anode or Cathode) Driving Capability
- Supply Voltage Range = 3.0 V to 18 V
- Capable of Driving 2 Low–power TTL Loads, 1 Low–power Schottky TTL Load or 2 HTL Loads Over the Rated Temperature Range
- Pin–for–Pin Replacement for CD4056A (with Pin 7 Tied to V_{SS}).
- Chip Complexity: 207 FETs or 52 Equivalent Gates
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.
- This Device is Pb-Free and is RoHS Compliant



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SOIC-16 D SUFFIX CASE 751B

PIN ASSIGNMENT

LD		1●		
С		2	15] f
В		3	14	g
D		4	13] e
Α	d	5	12] d
РΗ	d	6	11] c
ВІ	d	7	10] b
/ _{SS}	4	8	9] a

MARKING DIAGRAM



A = Assembly Location

WL, L = Wafer Lot YY, Y = Year

WW, W = Work Week
G = Pb-Free Package

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

MAXIMUM RATINGS (Voltages Referenced to V_{SS})

Parameter	Symbol	Value	Unit
DC Supply Voltage Range	V _{DD}	-0.5 to +18.0	V
Input Voltage Range, All Inputs	V _{in}	-0.5 to V _{DD} +0.5	V
DC Input Current per Pin	I _{in}	±10	mA
Power Dissipation per Package (Note 1)	P _D	500	mW
Operating Temperature Range	T _A	-55 to +125	°C
Storage Temperature Range	T _{stg}	-65 to +150	°C
Maximum Continuous Output Drive Current (Source or Sink)	I _{OHmax} I _{OLmax}	10 (per Output)	mA
Maximum Continuous Output Power (Source or Sink) (Note 2)	P _{OHmax} P _{OLmax}	70 (per Output)	mW

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Temperature Derating: "D/DW" Package: -7.0 mW/°C From 65°C To 125°C

2. $P_{OHmax} = I_{OH} (V_{OH} - V_{DD})$ and $P_{OLmax} = I_{OL} (V_{OL} - V_{SS})$ This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, Vin and Vout should be constrained to the range $V_{SS} \le (V_{in} \text{ or } V_{out}) \le V_{DD}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{DD}). Unused outputs must be left open.

TRUTH TABLE

Inputs						Outputs								
LD	ВІ	Ph*	D	С	В	Α	а	b	С	d	е	f	g	Display
Х	1	0	Χ	Χ	Χ	Χ	0	0	0	0	0	0	0	Blank
1	0	0	0	0	0	0	1	1	1	1	1	1	0	0
1	0	0	0	0	0	1	0	1	1	0	0	0	0	1
1	0	0	0	0	1	0	1	1	0	1	1	0	1	2
1	0	0	0	0	1	1	1	1	1	1	0	0	1	3
1	0	0	0	1	0	0	0	1	1	0	0	1	1	4
1	0	0	0	1	0	1	1	0	1	1	0	1	1	5
1	0	0	0	1	1	0	1	0	1	1	1	1	1	6
1	0	0	0	1	1	1	1	1	1	0	0	0	0	7
1	0	0	1	0	0	0	1	1	1	1	1	1	1	8
1	0	0	1	0	0	1	1	1	1	1	0	1	1	9
1	0	0	1	0	1	0	0	0	0	0	0	0	0	Blank
1	0	0	1	0	1	1	0	0	0	0	0	0	0	Blank
1	0	0	1	1	0	0	0	0	0	0	0	0	0	Blank
1	0	0	1	1	0	1	0	0	0	0	0	0	0	Blank
1	0	0	1	1	1	0	0	0	0	0	0	0	0	Blank
1	0	0	1	1	1	1	0	0	0	0	0	0	0	Blank
0	0	0	Х	Χ	Χ	Χ		**				**		
†	†	†		†			Inverse of Output Combinations Above					Display as above		

X = Don't care

† = Above Combinations

^{* =} For liquid crystal readouts, apply a square wave to Ph For common cathode LED readouts, select Ph = 0 For common anode LED readouts, select Ph = 1

 $^{^{**}}$ = Depends upon the BCD code previously applied when LD = 1

ELECTRICAL CHARACTERISTICS (Voltages Referenced to V_{SS})

			- 5	5°C	25°C			125		
Characteristic	Symbol	V _{DD} Vdc	Min	Max	Min	Typ (Note 3)	Max	Min	Max	Unit
Output Voltage "0" Level $V_{in} = V_{DD}$ or 0	V _{OL}	5.0 10 15	- - -	0.05 0.05 0.05		0 0 0	0.05 0.05 0.05	- - -	0.05 0.05 0.05	Vdc
$V_{in} = 0$ or V_{DD}	V _{OH}	5.0 10 15	4.95 9.95 14.95	- - -	4.95 9.95 14.95	5.0 10 15	- - -	4.95 9.95 14.95	- - -	Vdc
Input Voltage "0" Level (V _O = 4.5 or 0.5 Vdc) (V _O = 9.0 or 1.0 Vdc) (V _O = 13.5 or 1.5 Vdc)	V _{IL}	5.0 10 15	- - -	1.5 3.0 4.0	- - -	2.25 4.50 6.75	1.5 3.0 4.0	- - -	1.5 3.0 4.0	Vdc
"1" Level $(V_O = 0.5 \text{ or } 4.5 \text{ Vdc})$ $(V_O = 1.0 \text{ or } 9.0 \text{ Vdc})$ $(V_O = 1.5 \text{ or } 13.5 \text{ Vdc})$	V _{IH}	5.0 10 15	3.5 7.0 11	- - -	3.5 7.0 11	2.75 5.50 8.25	- - -	3.5 7.0 11	_ _ _	Vdc
Output Drive Current ($V_{OH} = 2.5 \text{ Vdc}$) Source ($V_{OH} = 4.6 \text{ Vdc}$) ($V_{OH} = 0.5 \text{ Vdc}$) ($V_{OH} = 9.5 \text{ Vdc}$) ($V_{OH} = 13.5 \text{ Vdc}$)	ІОН	5.0 5.0 10 10	-3.0 -0.64 - -1.6 -4.2	- - - -	-2.4 -0.51 - -1.3 -3.4	-4.2 -0.88 -10.1 -2.25 -8.8	- - - -	-1.7 -0.36 - -0.9 -2.4	- - -	mAdc
$(V_{OL} = 0.4 \text{ Vdc})$ Sink $(V_{OL} = 0.5 \text{ Vdc})$ $(V_{OL} = 9.5 \text{ Vdc})$ $(V_{OL} = 1.5 \text{ Vdc})$	I _{OL}	5.0 10 10 15	0.64 1.6 - 4.2	- - - -	0.51 1.3 - 3.4	0.88 2.25 10.1 8.8	- - - -	0.36 0.9 - 2.4	- - -	mAdc
Input Current	I _{in}	15	_	±0.1	-	±0.00001	±0.1	_	±1.0	μAdc
Input Capacitance	C _{in}	-	_	-	-	5.0	7.5	_	-	pF
Quiescent Current (Per Package) $V_{in} = 0$ or V_{DD} , $I_{out} = 0$ μA	I _{DD}	5.0 10 15	- - -	5.0 10 20	- - -	0.005 0.010 0.015	5.0 10 20	- - -	150 300 600	μAdc
Total Supply Current (Note 4, 5) (Dynamic plus Quiescent, Per Package) (C _L = 50 pF on all outputs, all buffers switching)	I _T	5.0 10 15			$I_T = (3)$	1.6 μΑ/kHz) f 3.1 μΑ/kHz) f 4.7 μΑ/kHz) f	+ I _{DD}	,		μAdc

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Noise immunity specified for worst-case input combination.

```
Noise Margin for both "1" and "0" level = 1.0 \text{ V} min @ \text{V}_{\text{DD}} = 5.0 \text{ V}

2.0 \text{ V} min @ \text{V}_{\text{DD}} = 10 \text{ V}

2.5 \text{ V} min @ \text{V}_{\text{DD}} = 15 \text{ V}
```

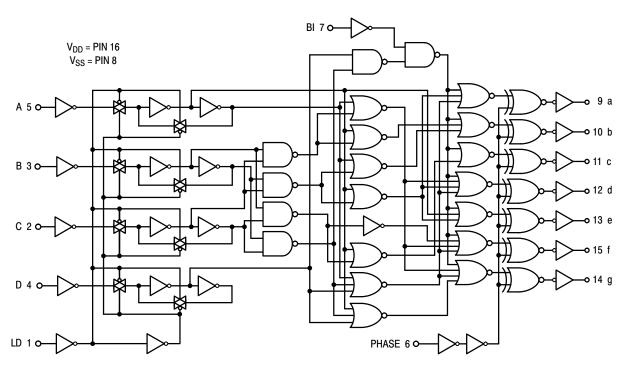
- 4. To calculate total supply current at loads other than 50 pF: I_T(C_L) = I_T(50 pF) + 3.5 x 10⁻³ (C_L 50) V_{DD}f where: I_T is in μA (per package), C_L in pF, V_{DD} in V, and f in kHz is input frequency.
 5. The formulas given are for the typical characteristics only at 25°C.

SWITCHING CHARACTERISTICS (Note 6) ($C_L = 50 \text{ pF}, T_A = 25^{\circ}\text{C}$)

Characteristic	Symbol	V_{DD}	Min	Тур	Max	Unit
Output Rise Time $t_{TLH} = (3.0 \text{ ns/pF}) C_L + 30 \text{ ns}$ $t_{TLH} = (1.5 \text{ ns/pF}) C_L + 15 \text{ ns}$ $t_{TLH} = (1.1 \text{ ns/pF}) C_L + 10 \text{ ns}$	t _{TLH}	5.0 10 15	- - -	100 50 40	200 100 80	ns
Output Fall Time $t_{THL} = (1.5 \text{ ns/pF}) \text{ C}_{L} + 25 \text{ ns} \\ t_{THL} = (0.75 \text{ ns/pF}) \text{ C}_{L} + 12.5 \text{ ns} \\ t_{THL} = (0.55 \text{ ns/pF}) \text{ C}_{L} + 12.5 \text{ ns}$	t _{THL}	5.0 10 15	- - -	100 50 40	200 100 80	ns
Turn–Off Delay Time $t_{PLH} = (1.7 \text{ ns/pF}) C_L + 520 \text{ ns}$ $t_{PLH} = (0.66 \text{ ns/pF}) C_L + 217 \text{ ns}$ $t_{PLH} = (0.5 \text{ ns/pF}) C_L + 160 \text{ ns}$	t _{PLH}	5.0 10 15	- - -	605 250 185	1210 500 370	ns
Turn–On Delay Time $t_{PHL} = (1.7 \text{ ns/pF}) \text{ C}_{L} + 420 \text{ ns}$ $t_{PHL} = (0.66 \text{ ns/pF}) \text{ C}_{L} + 172 \text{ ns}$ $t_{PHL} = (0.5 \text{ ns/pF}) \text{ C}_{L} + 130 \text{ ns}$	t _{PHL}	5.0 10 15	- - -	505 205 155	1650 660 495	ns
Setup Time	t _{su}	5.0 10 15	350 450 500		- - -	ns
Hold Time	t _h	5.0 10 15	40 30 20		- - -	ns
Latch Disable Pulse Width (Strobing Data)	t _{WH}	5.0 10 15	250 100 80	125 50 40	- - -	ns

^{6.} The formulas given are for the typical characteristics only.

LOGIC DIAGRAM



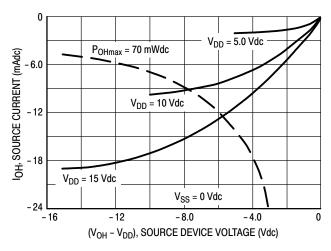


Figure 1. Typical Output Source Characteristics

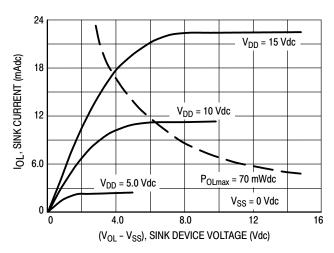
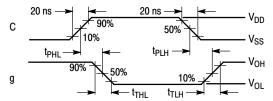
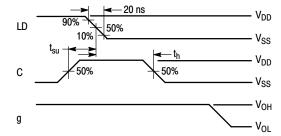


Figure 2. Typical Output Sink Characteristics

(a) Inputs D, Ph, and BI low, and Inputs A, B, and LD high.



(b) Inputs D, Ph, and BI low, and Inputs A and B high.



(c) Data DCBA strobed into latches

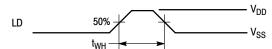


Figure 4. Dynamic Signal Waveforms

Inputs BI and Ph low, and Inputs D and LD high. f in respect to a system clock.

All outputs connected to respective C_L loads.

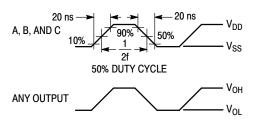
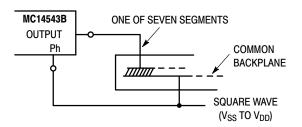


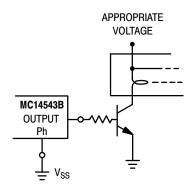
Figure 3. Dynamic Power Dissipation Signal Waveforms

CONNECTIONS TO VARIOUS DISPLAY READOUTS

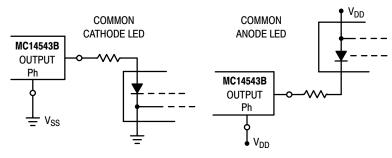
LIQUID CRYSTAL (LC) READOUT



INCANDESCENT READOUT

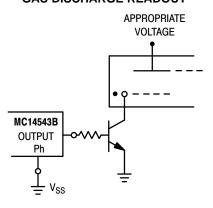


LIGHT EMITTING DIODE (LED) READOUT



NOTE: Bipolar transistors may be added for gain (for $V_{DD} \leq 10 \text{ V}$ or $I_{out} \geq 10 \text{ mA}$).

GAS DISCHARGE READOUT



CONNECTIONS TO SEGMENTS

$$e \int_{-\frac{d}{d}}^{\frac{a}{g}} \int_{c}^{b}$$

 $V_{DD} = PIN 16$ $V_{SS} = PIN 8$



ORDERING INFORMATION

Device	Package	Shipping [†]
MC14543BDG	SOIC-16 (Pb-Free)	48 Units / Rail
MC14543BDR2G	SOIC-16 (Pb-Free)	2500 / Tape & Reel
NLV14543BDR2G*	SOIC-16 (Pb-Free)	2500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP

Capable.





SOIC-16 CASE 751B-05 **ISSUE K**

DATE 29 DEC 2006

- NOTES:

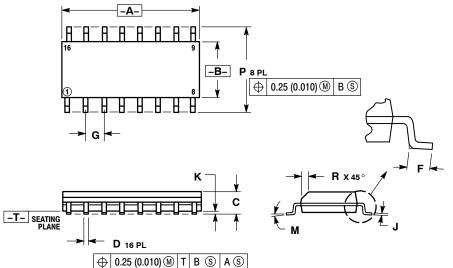
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: MILLIMETER.

 3. DIMENSIONS A AND B DO NOT INCLUDE MOLD DESCRIPTION AND BEAUTION AND BEAUTION AND BEAUTION AND BEAUTION AND BEAUTI

- PROTRUSION.
 MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
- DIMENSION D DOES NOT INCLUDE DAMBAR
 PROTRUSION. ALLOWABLE DAMBAR PROTRUSION. SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	9.80	10.00	0.386	0.393	
В	3.80	4.00	0.150	0.157	
C	1.35	1.75	0.054	0.068	
D	0.35	0.49	0.014	0.019	
F	0.40	1.25	0.016	0.049	
G	1.27	BSC	0.050 BSC		
7	0.19	0.25	0.008	0.009	
K	0.10	0.25	0.004	0.009	
M	0°	7°	0°	7°	
Р	5.80	6.20	0.229	0.244	
R	0.25	0.50	0.010	0.019	



2. 3. 4. 5. 6. 7. 8. 9. 10.	COLLECTOR BASE EMITTER NO CONNECTION EMITTER BASE COLLECTOR COLLECTOR BASE EMITTER NO CONNECTION	2. 3. 4. 5. 6. 7. 8. 9. 10.	CATHODE ANODE NO CONNECTION CATHODE CATHODE NO CONNECTION ANODE CATHODE CATHODE CATHODE ANODE NO CONNECTION	2. 3. 4. 5. 6. 7. 8. 9. 10.	COLLECTOR, DYE #1 BASE, #1 EMITTER, #1 COLLECTOR, #1 COLLECTOR, #2 BASE, #2 EMITTER, #2 COLLECTOR, #2 COLLECTOR, #3 BASE, #3 EMITTER, #3	2. 3. 4. 5. 6. 7. 8. 9.	COLLECTOR, #3 COLLECTOR, #4 COLLECTOR, #4 COLLECTOR, #4 BASE, #4 EMITTER, #4 BASE, #3	1	
12.	EMITTER BASE		CATHODE CATHODE	12.		12.		BECOM	MMENDED
13. 14.	COLLECTOR	13.	NO CONNECTION	13.	COLLECTOR, #4 BASE, #4	13. 14.	BASE, #2 EMITTER, #2		
15.	EMITTER		ANODE		EMITTER, #4	15.	BASE, #1	SOLDERING	G FOOTPRINT*
16.			CATHODE		COLLECTOR, #4		EMITTER, #1		8X
	002220.0		0,111002		0022201011,#1			L	6.40
STYLE 5:		STYLE 6:		STYLE 7:					0.40
	DRAIN, DYE #1		CATHODE		SOURCE N-CH				16X 1.12 <
2.	DRAIN, #1		CATHODE	2.	COMMON DRAIN (OUTPU	T)			
3.	DRAIN, #2	3.	CATHODE	3.	COMMON DRAIN (OUTPU			1	16
4.	DRAIN, #2	4.	CATHODE	4.	GATE P-CH	•,	1	<i>'</i> ==	
5.	DRAIN, #3	5.	CATHODE	5.	COMMON DRAIN (OUTPU	T)	_		
6.	DRAIN, #3	6.	CATHODE	6.	COMMON DRAIN (OUTPU	T)	16X		
7.	DRAIN, #4	7.	CATHODE	7.	COMMON DRAIN (OUTPU	T)	0.58 ^{_1}		
8.	DRAIN, #4	8.	CATHODE	8.	SOURCE P-CH				<u> </u>
9.	GATE, #4	9.	ANODE	9.	SOURCE P-CH				
10.	SOURCE, #4	10.	ANODE	10.	COMMON DRAIN (OUTPU		-		_
11.	GATE, #3	11.		11.	COMMON DRAIN (OUTPU				
12.	SOURCE, #3		ANODE	12.	COMMON DRAIN (OUTPU	T)			
13.	GATE, #2	13.		13.	GATE N-CH	_			
14.	SOURCE, #2		ANODE	14.	COMMON DRAIN (OUTPU				. ☐ ↓ PITCH
15.	GATE, #1		ANODE	15.	COMMON DRAIN (OUTPU	1)			
16.	SOURCE, #1	16.	ANODE	16.	SOURCE N-CH				
								8	9 + +

*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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